IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Johshi GOTOH et al.

Application No.: 10/019,299

Art Unit: 2827

Filed: March 11, 2002

Examiner: ALCALA, Jose H.

For UNDERFILLING MATERIAL FOR SEMICONDUCTOR PACKAGE

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents United States Patent and Trademark Office Washington, DC 20231

Sir:

In accordance with 37 CFR 1.56, 1.97, and 1.98, submitted herewith are copies of JP-2000-22048A and a corresponding English language abstract. The submitted reference is listed on the attached Form PTO 1449.

As this statement is being filed before first action on the merits, no fee is required. Should a fee be required, please charge it to Deposit Account No. 06-1358.

Respectfully submitted,

JACOBSON HOLMAN PLLC

By:

William E. Player Reg. No. 31,409

400 Seventh Street, N.W. Washington, DC 20004 (202) 638-6666 Attorney Docket No. P67440US0

Date: April 11, 2003

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Notice of References Cited

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Jos	e H Alcala	. 2827	Page 1 of 2			

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	Α	US-4,499,149	02-1985	Berger, Abe	428/447
	В	US-5,929,512	07-1999	Jacobs, Richard L.	257/667
	O	US-6,492,204	12-2002	Jacobs, Richard	438/127
	۵	US-6,406,990	06-2002	Kawai, Wakahiro	438/612
	ш	US-5,386,624	02-1995	George et al.	29/832
	F	US-5,390,082	02-1995	Chase et al.	361/783
	G	US-5,450,283	09-1995	Lin et al.	361/704
	Н	US-5,533,256	07-1996	Call et al.	29/840
	ı	US-5,804,882	09-1998	Tsukagoshi et al.	257/783
	J	US-5,288,944	02-1994	Bronson et al.	174/52.4
	К	US-5,249,101	09-1993	Frey et al.	361/717
	L	US-5,641,996	06-1997	Omoya et al.	257/787
	М	US-6,507,101	01-2003	Morris, Terrel L.	257/706

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
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Notice of References Cited

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U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	Α	US-6,534,858	03-2003	Akram et al.	257/706
	В	US-6,252,308	06-2001	Akram et al.	257/787
	Ċ	US-6,121,070	09-2000	Akram, Salman	438/108
	D	US-6,037,043	03-2000	Lehner et al.	428/209
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THA	JP2713760-B	0.9/1:990	JAPAN (English Abstract)			
JUA	JP2738487-B	0/3/11/194	JAPAN (English Abstract)			
JHA	JP10204259-A	0:3/1!198	JAPAN (English Abstract)			
JHA	WO 98/31738	01/11198	PCT			
THA	EP 0757067A1	03/11/95	EUROPEAN			
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*EXAMINER: Initial if reference considered, whether or not circuit is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered, include copy of this form with next communication to applicant R:Vthomas\2003\APRIL\P67440US0-PT01449.wpd

ATTY. DKT. NO. P67440US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Johshi GOTOH et al.

Serial No.: 10/019,299

Filed: January 7, 2002

For:

UNDERFILLING MATERIAL FOR SEMICONDUCTOR PACKAGE

INFORMATION DISCLOSURE STATEMENT

Commissioner of Patents Washington, DC 20231

Sir:

As a means of complying with the duty of disclosure under 37 CFR §1.56, and in accordance with 37 CFR §§1.97 and 1.98, Applicant(s), through the undersigned attorney, submits this Information Disclosure Statement. The patents, publications or other information submitted herewith are listed on the attached Form PTO-1449 and copies are attached. Cited in the International Search Report (copy attached) are WO 98/31738 A, EP O 757 067A, US 5,061,776, and "SOLDER JOINT LIFE IMPROVEMENT USING ADHESIVE UNDER COMPONENT" page 32. JP-10-204259-A is cited and discussed in the present specification.

In accordance with 37 CFR §1.97(b)(1) or (2), this Information Disclosure Statement is being filed either within three months of the filing date of the above-identified application, or

U.S. Patent Application No.: 10/019,299 Attorney Docket No.: P67440US0

within three months of the date of entry into the national stage of the above-identified application as set forth in 37 CFR §1.491. Accordingly, no fee is required.

Respectfully submitted,

JACOBSON HOLMAN PLLC

By:

illiam E. Player

Registration No. 31,409

Dated: March 25, 2002

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	5,061,776	10/1991	WEAVER et al.		·			
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		FOREI	GN PATENT DOCUME	NTS				
	DOCUMENT NUMBER	DATE	COUNTRY CLASS		SS SUBCLASS	TRANSLATION YES NO		
	JP2713760-B	09/1990	JAPAN (Englişh Abstract)					
	JP2738487-B	06/1994	JAPAN (English Abstract)					
	JP10204259-A	08/1998	JAPAN (English Abstract)					
	WO 98/31738	01/1998	PCT		·			
	EP 0757067A1	03/1995	EUROPEAN					
	OTHER ROOM	RACRITICA (La al-	udina Ausbas İsla B		The Paris of Start			
OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.) "Solder Joint Life Improvement Using Adhesive Under Component", Research Disclosure - 2244 - (January, 1990) No. 309, New York, US - XP 000099320								
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